

## BS-1 – Silicon / Titanium Nitride

## **MATERIAL TECHNICAL DATA SHEET**

TRADE NAME:	BS-1
MATERIAL DESCRIPTION Chemical Name & Formula:	Silicon / Titanium Nitride – Si₃N₄ + TiN
MAIN COMPONENTS	
Si3N4 / TiN:	>90% min
PHYSICAL DATA	
Physical Form:	Polycrystalline structure
Boiling Temperature:	N.A.
Vapour Pressure:	N.A.
Evaporation Rate:	N.A.
Specific gravity:	N.A.
Density:	≥3,96g/cm <sup>3</sup>
Water solubility:	Insoluble
Colour:	Bronze
Odour:	None
MECHANICAL PROPERTIES AT ROOM TEMPERATURE	
Water Absorption	%
Vickers Hardness	(HV 0,5)
Flexural Strength	MPa
Compressive Strength	MPa
Young's Modulus	GPa 2
Thermal Conductivity @20°C	W/(m·K) З
Thermal Conductivity @1000°C	W/(m·K) 2
Thermal Expansion Coefficient (RT-1000	°C) 10 <sup>-6</sup> /°C 5

## **PHYSICAL AND CHEMICAL PROPERTIES**

Good thermal shock and wear resistance.

Not magnetic material.

The material is electroconductive: it can be processed by electroerosion.

Please, note that all values quoted are based on test pieces and may vary according to component design. These values are not guaranteed in any way and should only be treated as indicative values. They should be used for guidance only and for no other purpose.



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